



Technical note

ST60A3H1 packing information

Introduction

This document complements the ST60A3H1 datasheet (DS14598) by providing additional information on device packing.



1 Tray packing information

This section provides information related to the dimensions, tolerances and characteristics of the tray packing for VFBGA $2.9 \times 4.1 \times 0.8$ mm package.

Table 1. Tray packing information

Package	Matrix	Base quantity	Bulk quantity
VFBGA 2.9 x 4.1	14 x 35	490	2940

TN1603 - Rev 1 page 2/11



X SEE DETAIL "D" (SEE SHT.#2) -315.0 - 5.62 -7.62 VACUUM PICKUP CELLS Ф 0.20M A XM ⊕ 0.20 A Z -311.15^{+0.25} -132.08^{+0.25}-Ф0.20(M) A X (M) Ф0.20® A Z® 135.9 SEE DETAIL "Q" SECTION "X-X" SECTION "Y-Y" TRAY STACKING DETAIL SCALE: 3/1 В 8.15 - [8.80] -[7.90] R1.6 3 PLACES SEE DETAIL "C" CHAMFER 3.0X45* -299.2±0.25-C SEE DETAIL "H" DETAIL "Q" SCALE : 2/1 REFERENCE DETAIL "H" SCALE: 3/1 DETAIL "P" SCALE : 2/1 REFERENCE SEE DETAIL "P"

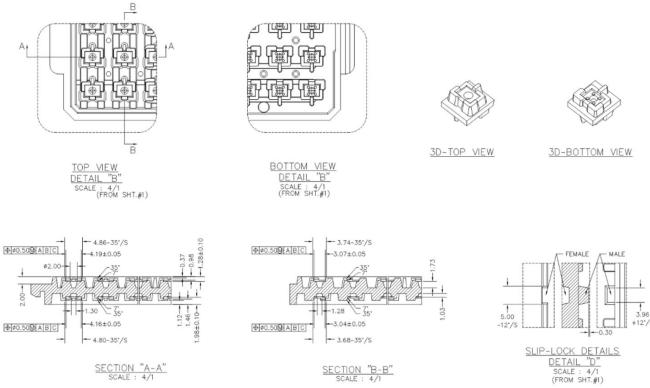
BOTTOM FULL VIEW

DETAIL SCALE :

Figure 1. Tray design - bottom full view



Figure 2. Tray design - detailed view



DT77096V1



2 Tape and reel packing information

2.1 Reel dimensions and tape orientation

This section provides information related to the dimensions, tolerances and characteristics of the tape and reel packing for VFBGA 2.9 x 4.1 x 0.8 mm package.

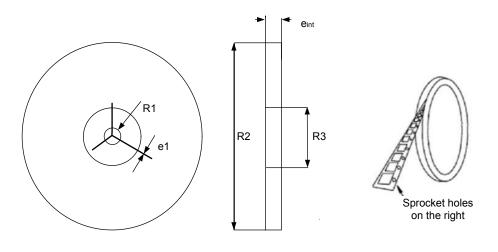
Table 2. Tape and reel information

Package	Tape width (W)	Part pitch (P)	Quantity
VFBGA 2.9 x 4.1	12 mm	8 mm	5000

Table 3. Reel dimensions

Reel diameter	R1	R2	R3
13"	13 mm	330 mm	100 mm

Figure 3. Reel dimensions and tape orientation



2.2 Carrier tape dimensions

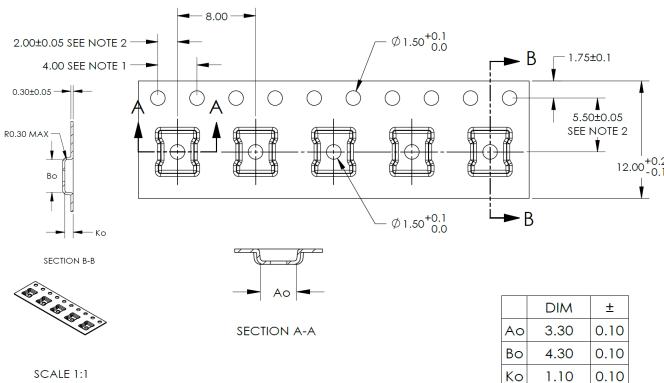
Table 4. Carrier tape dimensions

Reference	Dimension	Deviation
Ao	3.30	
Во	4.30	±0.10
Ко	1.10	

TN1603 - Rev 1 page 5/11

JT77098V1

Figure 4. Carrier tape dimensions

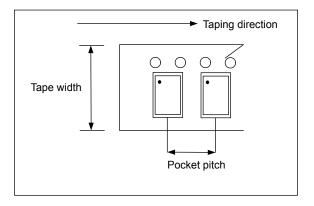


Note:

- 1. 10 sprocket hole pitch cumulative tolerance ±0.2.
- 2. Pocket position relative to sprocket hole measured as true position of the pocket, not the pocket hole.
- 3. Ao and Bo are measured on a plane at a distance R above the bottom of the pocket

2.3 Device orientation on tape

Figure 5. Device orientation on tape



DT77099V1

Note: The ball 1 location is on the top left corner of the package.



Revision history

Table 5. Document revision history

Date	Version	Changes
17-Jul-2025	1	Initial release.

TN1603 - Rev 1 page 7/11



Contents

1	Tray	packing information	.2
2	Tape	e and reel packing information	.5
	2.1	Reel dimensions and tape orientation	. 5
	2.2	Carrier tape dimensions	. 5
	2.3	Device orientation on tape	. 6
Rev	ision	history	.7
List	of tal	oles	.9
List	of fig	ures	10





List of tables

Table 1.	Tray packing information	2
Table 2.	Tape and reel information	2
Table 3.	Reel dimensions	-
Table 4.	Carrier tape dimensions	5
Table 5.	Document revision history	7

TN1603 - Rev 1 page 9/11





List of figures

Figure 1.	Tray design - bottom full view
Figure 2.	Tray design - detailed view4
Figure 3.	Reel dimensions and tape orientation
Figure 4.	Carrier tape dimensions
Figure 5.	Device orientation on tape

TN1603 - Rev 1 page 10/11



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TN1603 - Rev 1 page 11/11